BSN20
SOT-23 Plastic-Encapsulate MOSFETS

V_{DSS}	50	V
I_D	0.2	A
$R_{DS(ON)}$	3.5	Ω

FEATURES

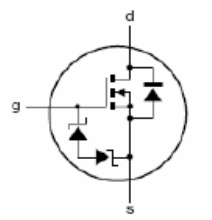
High density cell design for low $R_{DS(ON)}$
Voltage controlled small signal switch
Rugged and reliable
High saturation current capability

SS



SOT23 top view

Equivalent Circuit



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings Tc=25℃ unless otherwise noted

Symbol	Parameter	Rating	Unit
V_{DSS}	Drain-Source Voltage	50	V
V_{GSS}	Gate-Source Voltage	± 20	
I_D	Drain Current-Continuous	0.2	A

Electrical Characteristics T_J=25°C unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_{DS} = 250 μA	50	-	-	V
		V_{GS} = 0 V, I_{DS} = 10 μA	50	-	-	
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_{DS} = 250 μA	0.5	-	1.5	V
I_{DSS}	Drain Leakage Current	V_{DS} = 50 V, V_{GS} = 0V	-	-	500	nA
		V_{DS} = 25 V, V_{GS} = 0V	-	-	100	μA
I_{GSS}	Gate Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V	-	-	±100	μA
$R_{DS(ON)}$[a]	On-State Resistance	V_{GS} = 5 V, I_{DS} = 0.2 A	-	-	3.5	Ω
		V_{GS} = 2.75 V, I_{DS} = 0.2 A	-	-	10	
C_{iss}	Input Capacitance	VDS = 10 V, VGS = 0 V f = 1 MHz	-	21.8	40	pF
C_{oss}	Output Capacitance		-	5.6	15	
C_{rss}	Reverse Transfer Capacitance		-	3.3	10	
Diode Characteristics						
V_{SD}	Diode Forward Voltage	I_{SD} = 0.2 A, V_{GS} = 0 V	-	-	2.5	V

RATING AND CHARACTERISTIC CURVES

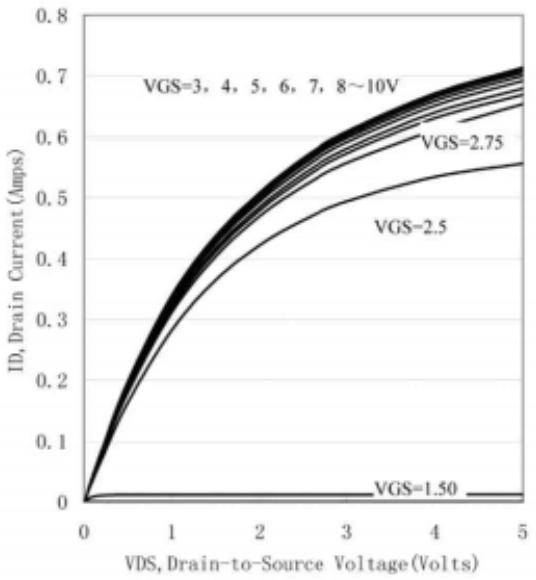


Figure 1. Output Characteristics

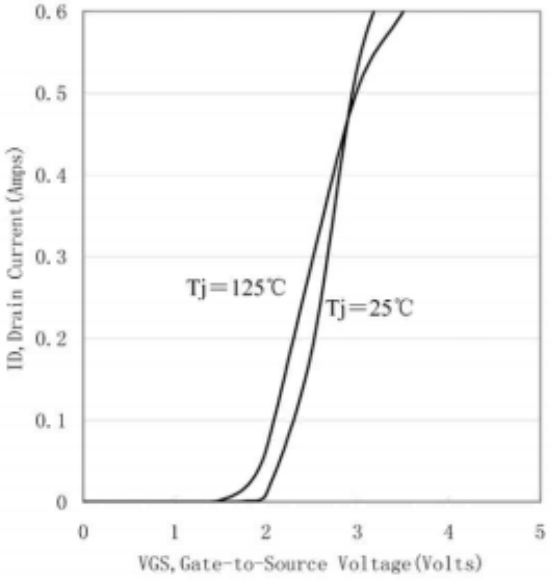


Figure 2. Transfer Characteristics

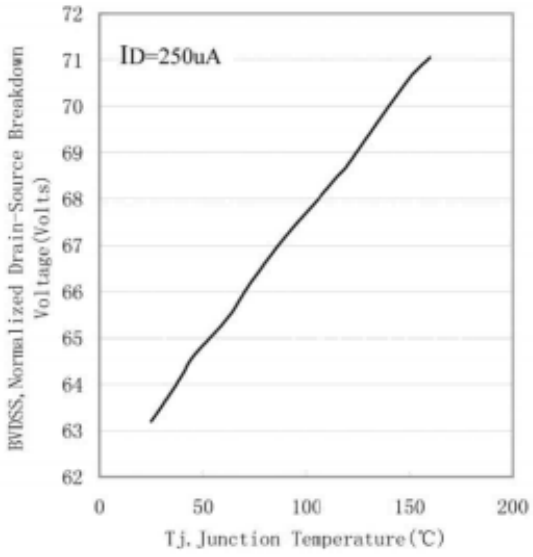


Figure 3. Breakdown Voltage Variation with Temperature

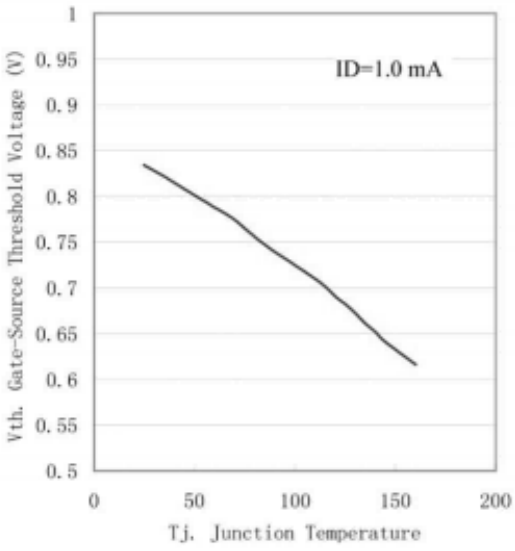
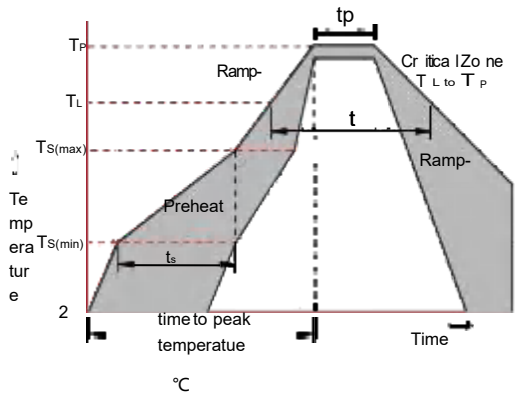


Figure 4. Gate Threshold Variation with Temperature

Soldering parameters

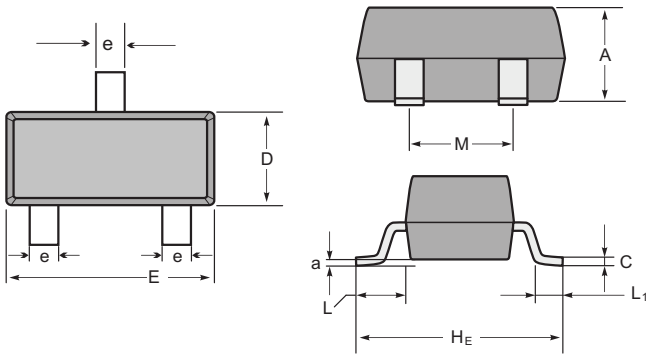
Reflow Condition		Pb-Free assembly (see as bellow)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150℃
	-Temperature Max($T_{s(max)}$)	+200℃
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3℃/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3℃/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217℃
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)℃
Time within 5℃ of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6℃/sec. Max
Time 25℃ to Peak Temp (T_P)		8 min. Max
Do not exceed		+260℃

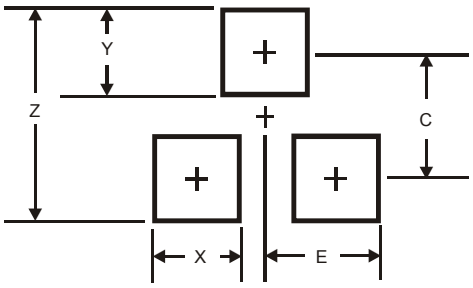
FIG5: Reflow condition



Package Dimensions & Suggested Pad Layout

SOT23





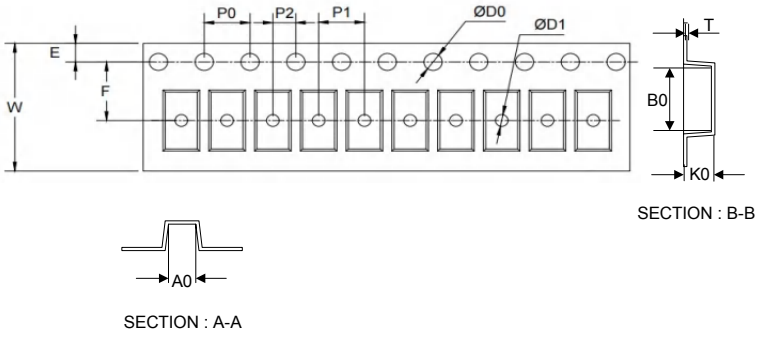
SOT-23 mechanical data

UNIT		A	C	D	E	H_E	e	M	L	L_1	a
mm	max	1.1	0.15	1.4	3.0	2.6	0.5	1.95	0.55 (ref)	0.36 (ref)	0.0
	min	0.9	0.08	1.2	2.8	2.2	0.3	1.7			0.15
mil	max	43	6	55	118	102	20	77	22 (ref)	14 (ref)	0.0
	min	35	3	47	110	87	12	67			6

Dimensions	SOT23
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

Tape & rell specification

Tape

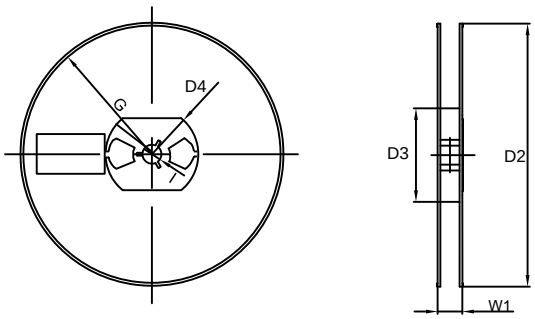


SECTION : B-B

SECTION : A-A

Symbol	Dimension (mm)
P0	4.00±0.10
P1	4.00±0.10
P2	2.00±0.10
D0	1.55±0.10
D1	1.05±0.10
E	1.55±0.10
F	3.60±0.10
W	8.00±0.10
A0	3.80±0.20
B0	3.25±0.20
K0	1.45±0.10
T	0.25±0.05

7” Reel



D2	178.0±3.0
D3	55Min.
D4	R24.0±3.0
G	R82.0±3.0
I	13.0±2.0
W1	11.0±3.0

Quantity: 3000PCS